### KAMAYA OHM

No.: FCCR-K-HTS-0001 /6

Date: 2023. 1. 25

## Data sheet

Title: CHIP FUSE; RECTANGULAR TYPE

Style: FCCR10,16

# RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature:  $+5^{\circ}C \sim +35^{\circ}C$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya FCCR-K-HTS-0001

CHIP FUSES: RECTANGULAR TYPE

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#### 1. Scope

1.1 This data sheet covers the detail requirements for chip fuses; rectangular type, style of FCCR10,16.

#### 1.2 Applicable documents

UL248-1-2000 Low-Voltage Fuses-Part1: General Requirements

UL248-14-2000 Low-Voltage Fuses-Part14: Supplemental Fuses

CSA C22.2 No.248.1-2000 Low-Voltage Fuses-Part1: General Requirements

CSA C22.2 No.248.14-2000 Low-Voltage Fuses-Part14: Supplemental Fuses

IEC60127-1 Miniature fuses-part 1: Definitions for miniature fuses and general requirements for miniature fuse-links

IEC60127-4 Miniature fuses-Part4: Universal modular fuse-links (UMF)

#### 2. Classification

Type designation shall be the following form.

(Example)

FCCR	10	201	AB	PA
1	2	3	4	5
Style				

1 Chip fuses; rectangular type

2 Size

3 Rated current

201   201> 0.2A	201	
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4 Optional code

Symbol	Content
AB	Standard

5 Packaging form

- 3 3 -	
В	Bulk (loose package)
PA	Press pocket taping
TP	Paper taping

#### 3. Safety standard approval

- UL248-1 and UL248-14
- CSA C22.2, No. 248.1–00 and CSA C22.2, No. 248.14–00

The file number to be designated by UL and C-UL shall be as follows: E176847

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#### 4. Rating

4.1 The ratings shall be in accordance with Table-1.

Table-1

	R	ated curre	nt	Internal	Rated	Breaking	Time / cu	rrent characteristic	
Style	Symbol	(A)	Marking symbol	resistance value $(m\Omega \max.)$	voltage (V)	capacity (A)	Current	Pre-arcing time	
	151	0.15	<u>n</u>	1850		, ,		F 2 7221	
	201	0.2	Z	1250	DC24	35			
FCCR10	251	0.25	С	880			200%		
FUCKIU	321	0.315	D	600	DC24	33	200%	5 s max.	
	401	0.4	Е	400					
	501	0.5	F	300					
	151	0.15	OB	2300			200%	5 s max.	
	201	0.2	ZB	1350					
	251	0.25	CB	1000	DC50				
	321	0.315	DB	600					
	401	0.4	EB	450					
	501	0.5	FB	300					
	631	0.63	IB	220					
FCCR16	751	0.75	AB	190		50			
	801	0.8	KB	165					
	102	1.0	LB	130					
	132	1.25	MB	110					
	152	1.5	HB	90					
	162	1.6	NB	75					
	202	2.0	SB	65					
	252	2.5	TB	40					

4.2 Working temperature range: -55 to +125(°C)

#### 5. Packaging form

The standard packaging form shall be in accordance with Table-2.

#### Table-2

Symbol	Packaging form		form Standard packaging quantity / units	
В	Bulk (loose package)		1,000 pcs.	FCCR10,16
PA	Press pocket taping (paper taping)  8mm width, 2mm pitches		10,000 pcs.	FCCR10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	FCCR16

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#### 6. Dimensions

6.1 The resistor shall be of the design and physical dimensions in accordance with Figure-1 and Table-3.

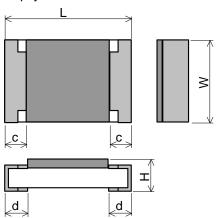


Figure-1

	Unit:mm				
Style	L	W	Н	С	d
FCCR10	1.0±0.05	0.5±0.05	0.4±0.05	0.2±0.1	0.25±0.10
FCCR16	1.6±0.1	0.8 +0.15	0.45±0.10	0.3±0.15	0.3±0.1

#### 6.2 Net weight (Reference)

Style	Net weight(mg)
FCCR10	0.8
FCCR16	2

#### 7. Marking

The Marking symbol of Sub– clause 4.1 shall be marked on over coat side.

#### (Example)

Style	Optional code	Marking symbol	Content
FCCR10	AB	Z	FCCR10 201 AB
FCCR16	AB	FB	FCCR16 401 AB



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#### 8. Performance

8.1 Unless otherwise specified, the standard range of atmospheric conditions for tests is as follows;

Ambient temperature: 5 °C to 35 °C, Relative humidity: 45 % to 85 %, Air presser: 86 kPa to 106 kPa

If there is any doubt the results, measurements shall be made within the following:

Ambient temperature: 20 °C  $\pm$  2 °C, Relative humidity: 60 % to 70 %, Air presser: 86 kPa to 106 kPa

8.2 The performance shall be satisfied in Table-4.

Table-4(1)

		1able-4(1)	_		
No.	Test items	Condition of test			quirements
1	Temperature rise	The fuse shall be mounted on the test substrate as	75 °C ma	X.	
		shown in Figure–2.			
		Measurement temp.: 10 °C to 30 °C			
		Test current: Rated current			
		The temperature at the hottest point on the surface of			
		the fuse shall be measured after temperature			
_		equilibrium has been attained.			
2	Current carrying capacity	The fuse shall be mounted on the test substrate as	Without o	pening	
		shown in Figure–2.			
		Test current: 110 % of Rated current			
		Test temp.: 70 °C ± 2 °C			
	<b>T</b> / / / / / / / / / / / / / / / / / / /	Test period: 1h	0 " 1		Τ
3	Time / current characteristic	The fuse shall be mounted on the test substrate as	Optional code	Current	Pre-arcing
		shown in Figure–2.	AB	200%	time 5 s max.
		Test current shall be applied for continuously.	AD	200 /6	55 max.
4	Terminal bond strength of	JIS C 60068-2-21 Ue1	Change o	of internal re	esistance:
-	the face plating	The fuse shall be mounted on the test substrate as			00.010
	and lead planning	shown in Figure–2.			f mechanical
		Bending value: 3 mm (Among the fulcrums: 90 mm)	damage.		moonanica
		Duration: 10 s ± 1 s			
5	Resistance to soldering	Test by a piece.	Change of internal resistance:		esistance:
	heat	Temp. of solder bath: 260 °C ± 5 °C	±10%		
		Immersion time: $10 \text{ s} \pm 1 \text{ s}$	No evid	dence of	appearance
		After immersion into solder, leaving the room temp.	damage		
		for 1h or more, and then measure the internal			
		resistance.			
		Reflow soldering			
		Pre-heating: 150 °C ~ 180 °C, 120 s max.			
		Peak: 260 °C ± 5 °C, 10 s max.			
		Refrow cycle: 2 times			
		After immersion into solder, leaving the room temp.			
		for 1h or more, and then measure the internal			
		resistance.			
6	Solderability	JIS C 60068-2-58			al immersed shall
		Test by a piece			ered with a new
		Flux: Rosin–Methanol	coating of	solder.	
		Temp. of solder: bath: 235 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C			
		Immersion time: $2 s \pm 0.5 s$			

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Table-4(2)

No.	Test items	Condition of test	Performance requirements	
7	Rapid change temperature	JIS C 60068-2-14 Na	Change of internal resistance:	
		The fuse shall be mounted on the test substrate as	±10%	
		shown in Figure–2.	No evidence of appearance	
		Upper temperature: +125 °C	damage	
		Lower temperature: –55 °C		
		Duration of exposure at each temperature: 30 min.		
		Number of cycles: 5 cycles		
8	Endurance test	The fuse shall be mounted on the test substrate as	The voltage drop across the fuse	
		shown in Figure–2.	after the test shall not have	
		Test condition: Nominal ambient temp. and Relative	increased by more than 10 % of	
		humidity.	the value measured before test.	
		Test potential:		
		1. Cycle of 1 h "ON" and 15 min. "OFF" at 1.05 times		
		rated current for 100 cycles.		
		2. After above the test, 1.25 times rated current for		
		1h.		

#### 9. Test substrate

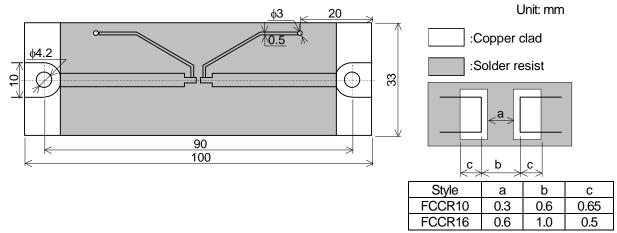


Figure-2 FCCR TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1. 6mm Thickness of copper clad: 0. 035mm

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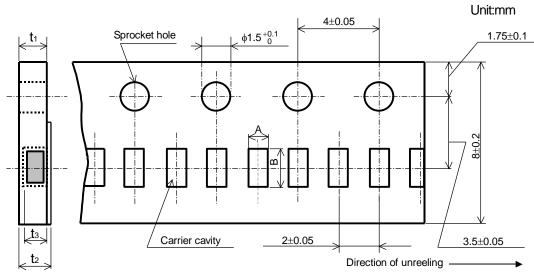
#### 10. Taping

10.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010

#### 10.2 Taping dimensions

10.2.1 Press pocket taping(8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



 Figure–3

 Table–5
 Unit:mm

 Style
 A
 B
 t<sub>1</sub>
 t<sub>2</sub>
 t<sub>3</sub>

 FCCR10
 0.65±0.1
 1.15±0.1
 0.6±0.05
 0.7max.
 0.5±0.05

#### 10.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.

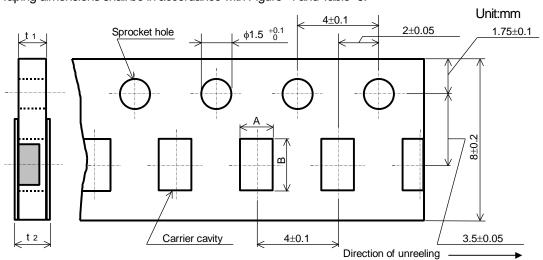


 Figure-4

 Table-6
 Unit:mm

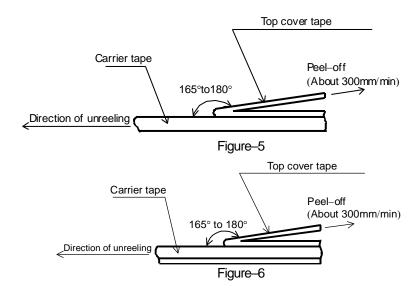
 Style
 A
 B
 t<sub>1</sub>
 t<sub>2</sub>

 FCCR16
 1.15±0.15
 1.9±0.2
 0.6±0.1
 0.8 max.

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following FCCR10:Figure–5,FCCR16: Figure–6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The fuses shall be faced to upward at the over coating side in the carrier cavity.

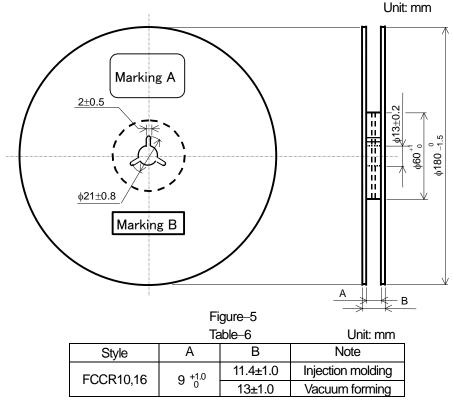


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#### 10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–5 and Table–6.

Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

#### 10.4 Leader and trailer tape.

(Example)

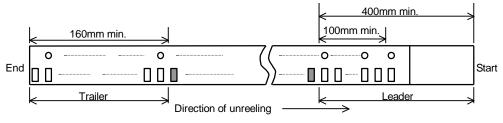


Figure-8

#### 11. Marking on package

The label of a minimum package shall be legibly marked with follows.

#### 11.1 Marking A

- (1) Classification (Style, Rated current, Optional code, Packaging form) (2) Quantity (3) Lot number
- (5) Manufacturer's name or trade mark (6) UL and /or C-UL recognized component mark (7) Others 11.2 Marking B (KAMAYA Control label)

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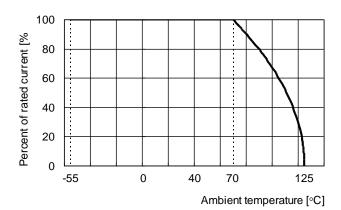
#### 12. Recommended Derating for Rated Current

Nominal Derating

Option Code AB: Nominal Derating ≤ 75% of Rated Current

Temperature Derating

Please refer to the following graph regarding the current derating value for ambient temperature.



Ex.) • If Optional code: AB (Rated Current:0.5A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below, Rated Current: 0.5A × (Nominal Derating: 75% × Temperature Derating: 100%) =0.375A